

# Global Semiconductor Wafer Dicing Machine Supply, Demand and Key Producers, 2023-2029

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## Abstracts

The global Semiconductor Wafer Dicing Machine market size is expected to reach \$ million by 2029, rising at a market growth of % CAGR during the forecast period (2023-2029).

The semiconductor wafer dicing machine divides the wafer containing many chips into wafer particles. The quality and efficiency of cutting directly affect the quality and production cost of chips. Semiconductor wafer dicing machine mainly includes grinding wheel dicing machine and laser dicing machine. Grinding wheel dicing machine is a precision numerical control equipment that integrates technologies such as water, gas, electricity, air static pressure high-speed spindle, precision mechanical transmission, sensors and automatic control. It is characterized by low cutting cost and high efficiency, and is suitable for cutting thicker wafers. The laser scribing machine uses a high-energy laser beam to irradiate the surface of the workpiece, so that the irradiated area is partially melted and vaporized, so as to achieve the purpose of scribing. It is characterized by high cutting precision and fast cutting speed, and is suitable for cutting thinner wafers.

This report studies the global Semiconductor Wafer Dicing Machine production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Semiconductor Wafer Dicing Machine, and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2022 as the base year. This report explores demand trends and competition, as well as details the characteristics of Semiconductor Wafer Dicing Machine that contribute to its increasing demand across many markets.

## Highlights and key features of the study

Global Semiconductor Wafer Dicing Machine total production and demand, 2018-2029, (K Units)

Global Semiconductor Wafer Dicing Machine total production value, 2018-2029, (USD Million)

Global Semiconductor Wafer Dicing Machine production by region & country, production, value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Semiconductor Wafer Dicing Machine consumption by region & country, CAGR, 2018-2029 & (K Units)

U.S. VS China: Semiconductor Wafer Dicing Machine domestic production, consumption, key domestic manufacturers and share

Global Semiconductor Wafer Dicing Machine production by manufacturer, production, price, value and market share 2018-2023, (USD Million) & (K Units)

Global Semiconductor Wafer Dicing Machine production by Type, production, value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Semiconductor Wafer Dicing Machine production by Application production, value, CAGR, 2018-2029, (USD Million) & (K Units)

This reports profiles key players in the global Semiconductor Wafer Dicing Machine market based on the following parameters – company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include DISCO Corporation, ACCRETECH, ASM, Synova, Genesem, Advanced Dicing Technologies (ADT), Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd, Zhuhai Bojay Electronics Co., Ltd and GL TECH CO., LTD, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals, COVID-19 and Russia-Ukraine War Influence.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Semiconductor Wafer Dicing Machine market

## Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (K Units) and average price (US\$/Unit) by manufacturer, by Type, and by Application. Data is given for the years 2018-2029 by year with 2022 as the base year, 2023 as the estimate year, and 2024-2029 as the forecast year.

## Global Semiconductor Wafer Dicing Machine Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

## Global Semiconductor Wafer Dicing Machine Market, Segmentation by Type

Grinding Wheel Dicing Machine

Laser Scribing Machine

## Global Semiconductor Wafer Dicing Machine Market, Segmentation by Application

Silicon Wafer

Ceramics

Glass

Optoelectronic Components

Others

#### Companies Profiled:

DISCO Corporation

ACCRETECH

ASM

Synova

Genesem

Advanced Dicing Technologies (ADT)

Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd

Zhuhai Bojay Electronics Co., Ltd

GL TECH CO., LTD

Shenyang Heyan Technology Co., Ltd

Wuhan Sunic Photoelectricity Equipment Manufacture Co., Ltd

ZHENGZHOU QISHENG PRECISION MANUFACTURING CO.,LTD

#### Key Questions Answered

1. How big is the global Semiconductor Wafer Dicing Machine market?

2. What is the demand of the global Semiconductor Wafer Dicing Machine market?
3. What is the year over year growth of the global Semiconductor Wafer Dicing Machine market?
4. What is the production and production value of the global Semiconductor Wafer Dicing Machine market?
5. Who are the key producers in the global Semiconductor Wafer Dicing Machine market?
6. What are the growth factors driving the market demand?

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